Power MOSFET 40 V, 123 A, Single N–Channel DPAK

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- MSL 1/260°C
- AEC Q101 Qualified and PPAP Capable
- 100% Avalanche Tested
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Motor Drivers
- Pump Drivers for Automotive Braking, Steering and Other High Current Systems

MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise noted)

Param	eter		Symbol	Value	Unit
Drain-to-Source Voltage	V _{DSS}	40	V		
Gate-to-Source Voltage	Gate-to-Source Voltage				V
Continuous Drain Cur-		$T_C = 25^{\circ}C$	I _D	123	А
rent (R _{θJC})		$T_C = 85^{\circ}C$		95	
Power Dissipation ($R_{\theta JC}$)	Steady	$T_C = 25^{\circ}C$	PD	107	W
Continuous Drain Cur-	State	$T_A = 25^{\circ}C$	I _D	24	А
rent (R _{θJA}) (Note 1)		$T_A = 85^{\circ}C$		18.5	
Power Dissipation $(R_{\theta JA})$ (Note 1)		$T_A = 25^{\circ}C$	PD	4.0	W
Pulsed Drain Current	t _p =10μs	$T_A = 25^{\circ}C$	I _{DM}	400	А
Current Limited by Packa	age	$T_A = 25^{\circ}C$	I _{DmaxPkg}	100	А
Operating Junction and S	Storage Te	mperature	T _J , T _{stg}	–55 to 175	°C
Source Current (Body Di	iode)		۱ _S	100	А
Drain to Source dV/dt	dV/dt	6.0	V/ns		
Single Pulse Drain-to-S ergy (V _{DD} = 32 V, V _{GS} = L = 0.3 mH, $I_{L(pk)}$ = 40 A	E _{AS}	240	mJ		
Lead Temperature for So (1/8" from case for 10 s)		irposes	ΤL	260	°C

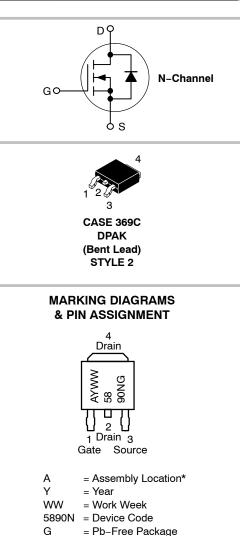
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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V _{(BR)DSS}	R _{DS(on)}	ID
40 V	$3.7~\mathrm{m}\Omega$ @ 10 V	123 A



* The Assembly Location Code (A) is front side optional. In cases where the Assembly Location is stamped in the package bottom (molding ejecter pin), the front side assembly code may be blank.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	$R_{\theta JC}$	1.4	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	37	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	76	

Surface-mounted on FR4 board using 650 mm² pad size, 2 oz Cu.
Surface-mounted on FR4 board using 36 mm² pad size.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Paramete	er Symbol	Test Condition	Min	Тур	Max	Unit

Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D =	= 250 μA	40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				40		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$			1.0	μΑ
		$V_{DS} = 40 V$	T _J = 150°C			100	
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS}	= ±20 V			±100	nA

ON CHARACTERISTICS (Note 3)

Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 250 μ A	1.5		3.5	V
Negative Threshold Temperature Co- efficient	V _{GS(TH)} /T _J			7.4		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 10 V, I _D = 50 A		2.9	3.7	mΩ
Forward Transconductance	gFS	V _{DS} = 15 V, I _D = 15 A		16.8		S

CHARGES AND CAPACITANCES

Input Capacitance	C _{iss}		4975		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 12 V	785		
Reverse Transfer Capacitance	C _{rss}		490		
Input Capacitance	C _{iss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 25 V	4760		pF
Output Capacitance	C _{oss}	V _{DS} = 25 V	580		
Reverse Transfer Capacitance	C _{rss}		385		
Total Gate Charge	Q _{G(TOT)}		74	100	nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 15 V,	5.0		
Gate-to-Source Charge	Q _{GS}	I _D = 50 Å	17		1
Gate-to-Drain Charge	Q _{GD}		16		1

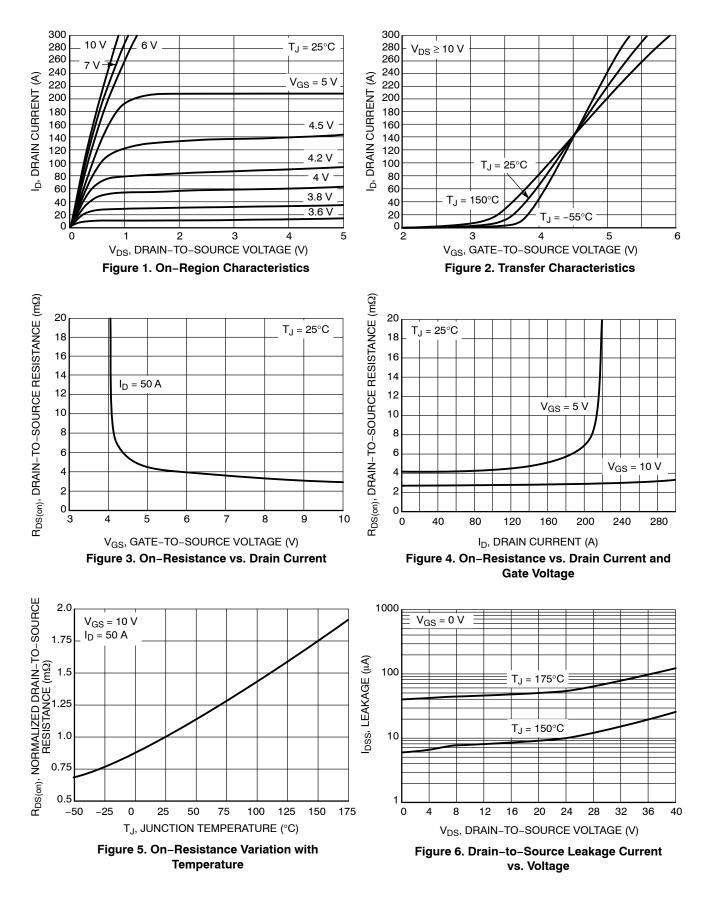
SWITCHING CHARACTERISTICS (Note 4)

Turn-On Delay Time	t _{d(on)}		14	ns
Rise Time	t _r	V _{GS} = 10 V, V _{DS} = 20 V,	55	
Turn-Off Delay Time	t _{d(off)}	$I_{\rm D} = 50 {\rm A}, {\rm R}_{\rm G} = 2.0 {\Omega}$	35	
Fall Time	t _f		7.0	

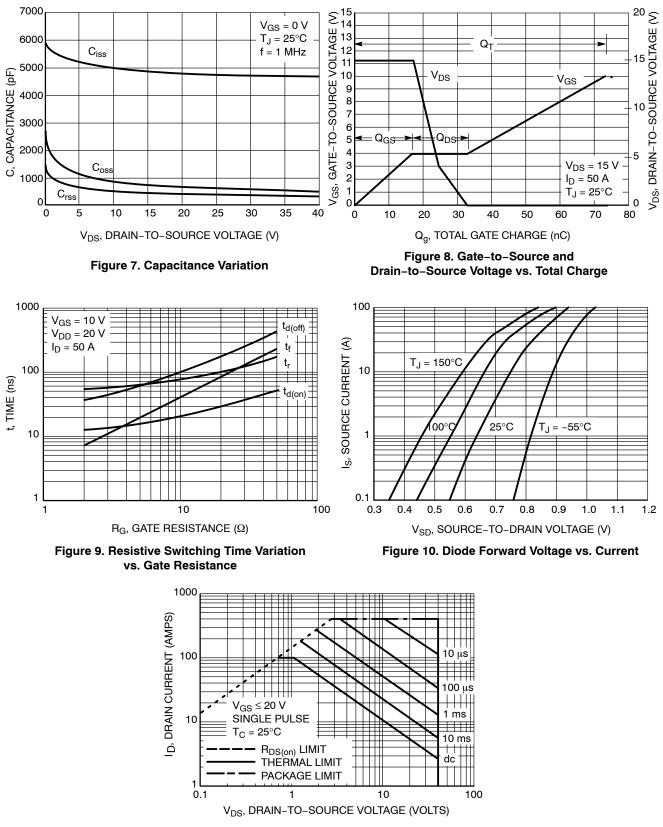
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Test Co	ndition	Min	Тур	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS							
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 50 A	$T_J = 25^{\circ}C$		0.9	1.2	V
		V _{GS} = 0 V, I _S = 20 A	T _J = 25°C		0.8	1.0	
Reverse Recovery Time	t _{RR}				35		ns
Charge Time	ta	V _{GS} = 0 V, dls/	dt = 100 A/μs,		20		
Discharge Time	tb	V _{GS} = 0 V, dls/ I _S = 5	50 A		15		
Reverse Recovery Charge	Q _{RR}				40		nC

TYPICAL PERFORMANCE CURVES



TYPICAL PERFORMANCE CURVES





TYPICAL PERFORMANCE CURVES

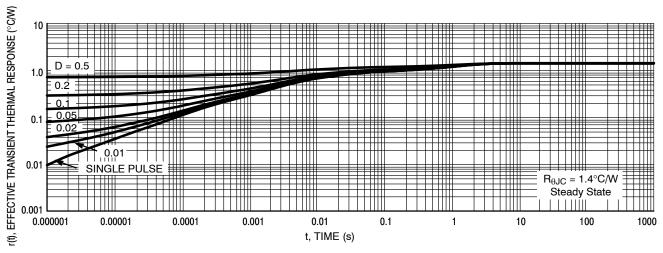


Figure 12. Thermal Response

ORDERING INFORMATION

Order Number	Package	Shipping [†]
NVD5890NT4G	DPAK (Pb-Free)	2500/Tape & Reel
NVD5890NT4G-VF01	DPAK (Pb-Free)	2500/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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